



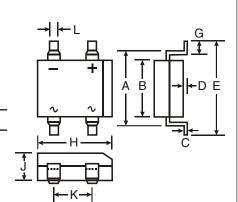
1.0A SURFACE MOUNT GLASS PASSIVATED BRIDGE **RECTIFIER**

Features

- Glass Passivated Die Construction
- **Diffused Junction**
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Surface Mount Application
- Plastic Material UL Flammability Classification 94V-0
- **UL Listed Under Recognized Component** Index, File Number E94661

Mechanical Data

- Case: Molded Plastic
- Terminals: Solder Plated Leads, Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish). Please see Ordering Information, Note 4, on Page 3
- Polarity: As marked on Case
- Approx. Weight: 0.38 grams
- Mounting Position: Any
- Marking: Type Number



DF-S						
Dim	Min	Max				
Α	7.40	7.90				
В	6.20	6.50				
С	0.22	0.30				
D	0.076	0.33				
E	_	10.40				
G	1.02	1.53				
Н	8.13	8.51				
J	2.40	2.60				
K	5.00	5.20				
L	1.00	1.20				
All Dimensions in mm						

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

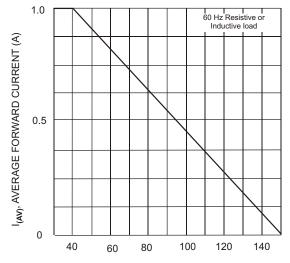
Single phase, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	DF 005S	DF 01S	DF 02S	DF 04S	DF 06S	DF 08S	DF 10S	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RMM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average Forward Rectified Current @ T _A = 40°C	l _O	1.0				Α			
Non-Repetitive Peak Forward Surge Current, 8.3 ms single half-sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	50				А			
Forward Voltage (per element) @ I _F = 1.0	A V _{FM}	1.1				V			
Peak Reverse Current at Rated @ T _A = 25°0 DC Blocking Voltage (per element) @ T _A = 125°0		10 500			μA				
I ² t Rating for Fusing (t<8.3ms)	I ² t	10.4			A ² s				
Typical Total Capacitance (per element) (Note 1)		25					pF		
Typical Thermal Resistance, Junction to Ambient (Note 2)		40					°C/W		
Operating and Storage Temperature Range		-65 to +150					°C		

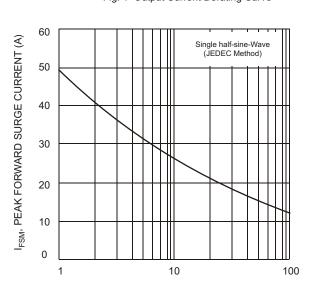
1. Measured at 1.0 MHz and Applied Reverse Voltage of 4.0V DC.

2. Thermal resistance, junction to ambient, measured on PC board with 5.0mm² (0.03mm thick) land areas.

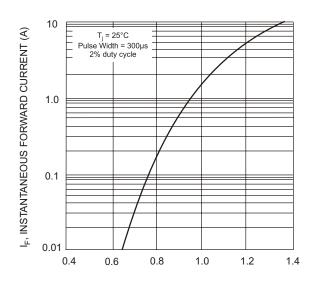




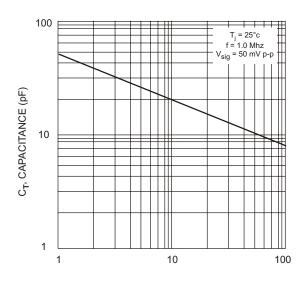
T_A, AMBIENT TEMPERATURE (°C) Fig. 1 Output Current Derating Curve



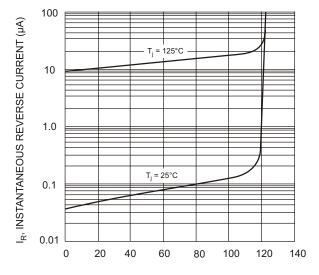
NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Forward Surge Current



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m V_{F}}$, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typ Forward Characteristics (per element)



 $\label{eq:VR} V_{R}\text{, REVERSE VOLTAGE (V)}$ Fig. 4 Typ Junction Capacitance (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%) Fig. 5 Typ Reverse Characteristics (per element)



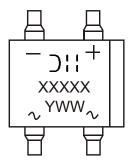
Ordering Information (Notes 3 & 4)

Device*	Packaging	Shipping			
DFxS	DF-S	Tube			
DFxS-T	DF-S	1500/Tape & Reel, 13-inch			

^{*} x = Device type, e.g. DF005S or DF10S, etc.

For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
 For lead free terminal plating part number, please add "-F" suffix to part number above. Example: DF10S-T-F.

Marking Information



DII= Manufacturers' code marking

XXXXX = Product type marking code, ex: DF10S

YWW = Date code marking

Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52